

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

Kingbright DA08-11CGKWA

For any questions, you can email us directly: <u>sales@integrated-circuit.com</u>



20.3mm (0.8INCH) DUAL DIGIT NUMERIC DISPLAY

The Green source color devices are made with AlGaInP on

Part Number: DA08-11CGKWA Green

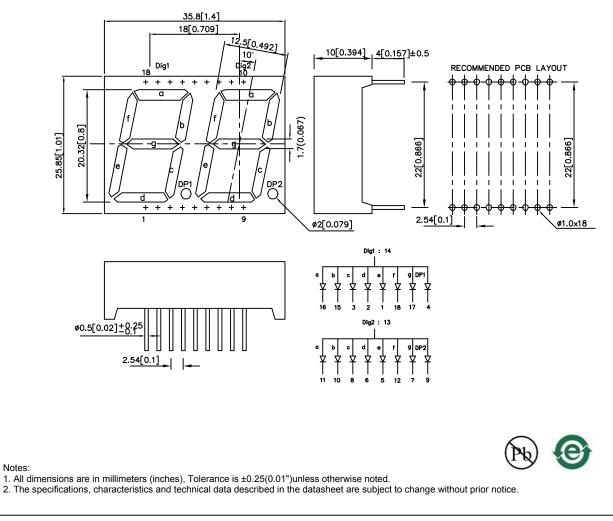
GaAs substrate Light Emitting Diode.

Description

Features

- 0.8 inch digit height.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Two digit package simplifies alignments & assembly.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

Package Dimensions& Internal Circuit Diagram





Selection Guide

Part No.	Dice	Lens Type	lv (ucd) [1] @ 10mA		Description	
			Min.	Тур.	• • • • • •	
DA08-11CGKWA	Green (AlGaInP)	White Diffused	14000	38000	Common Anode ,Rt. Hand Decimal.	
			*5600	*12000		

Notes:

1. Luminous intensity/ luminous Flux: +/-15%.

*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Green	574		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Green	570		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Green	20		nm	I⊧=20mA
С	Capacitance	Green	15		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Green	2.1	2.5	V	I⊧=20mA
IR	Reverse Current	Green		10	uA	VR=5V

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

4. Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Green	Units		
Power dissipation	75	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	150	mA		
Reverse Voltage	5	V		
Operating / Storage Temperature	-40°C To +85°C			
Lead Solder Temperature[2]	260°C For 3-5 Seconds			

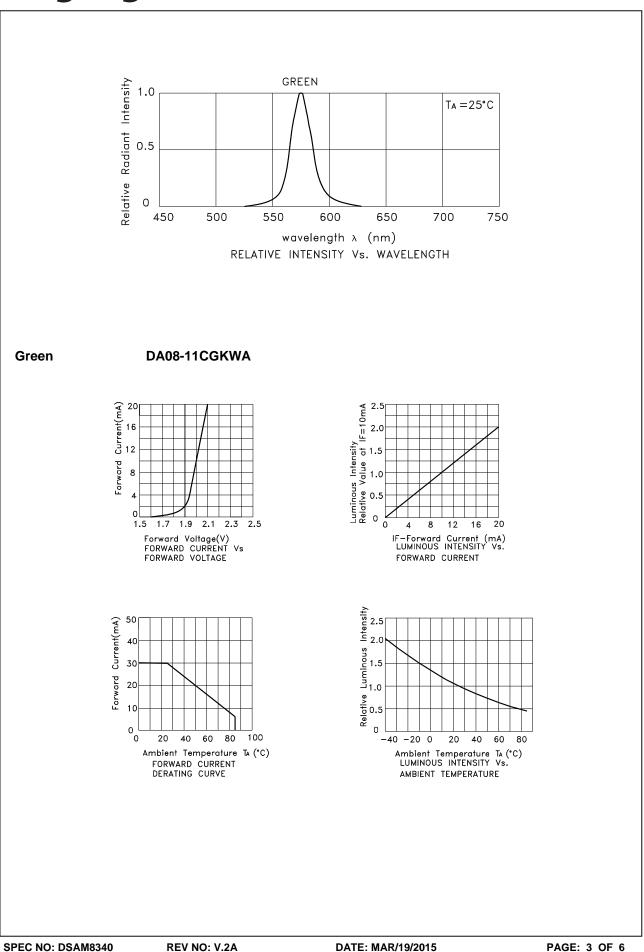
Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

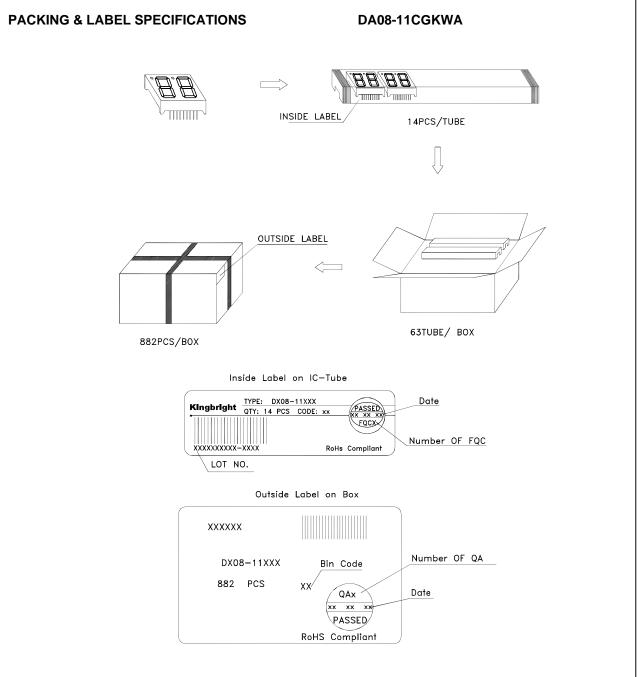
2. 2mm below package base.

^{3.} Wavelength value is traceable to the CIE127-2007 compliant national standards.









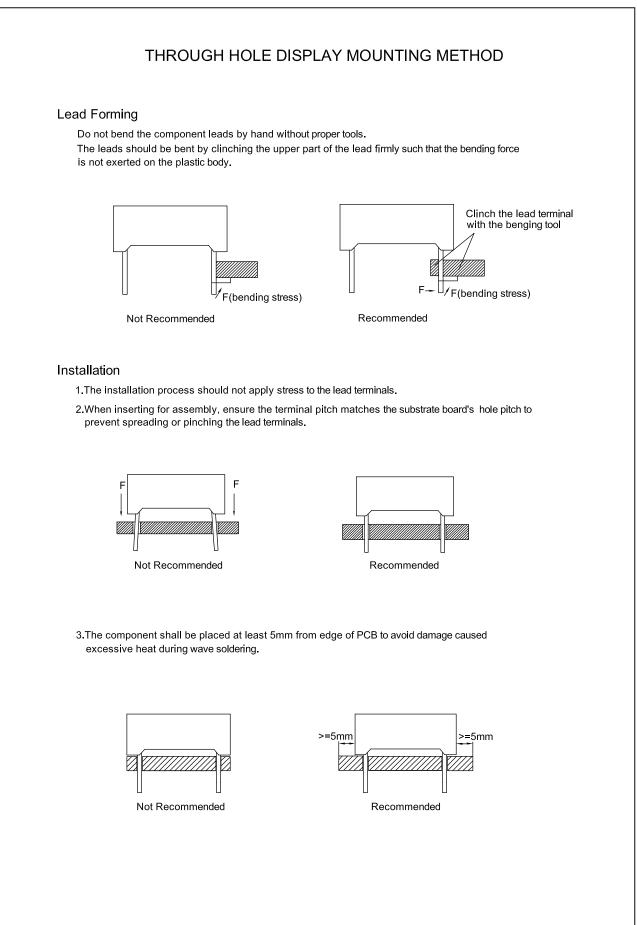
Terms and conditions for the usage of this document

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- 2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- 3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
- 4. The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.
- 5. The contents and information of this document may not be reproduced or re-transmitted without permission by Kingbright.
- 6. All design applications should refer to Kingbright application notes available at http://www.KingbrightUSA.com/ApplicationNotes

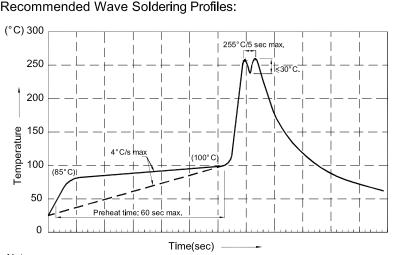
6

SPEC NO: DSAM8340	REV NO: V.2A	DATE: MAR/19/2015	PAGE: 4 OF









Notes:

- Recommend pre-heat temperature of 105° C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260° C
- 2 Peak wave soldering temperature between 245° C \sim 255° C for 3 sec (5 sec max).
- 3.Do not apply stress to the epoxy resin while the temperature is above $85^\circ\text{C}.$
- 4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5.SAC 305 solder alloy is recommended.
- 6.No more than one wave soldering pass.
- 7.During wave soldering, the PCB top-surface temperature should be kept below 105°C.

Soldering General Notes:

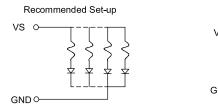
- 1. Through-hole displays are incompatible with reflow soldering.
- 2.If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

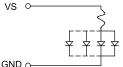
CLEANING

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only.
- Do not use harsh organic solvents for cleaning because they may damage the plastic parts .
- 3. The cleaning process should take place at room temperature and the devices should not be washed for more than one minute.
- 4.When water is used in the cleaning process, immediately remove excess moisture from the component with forced-air drying afterwards.

CIRCUIT DESIGN NOTES

- 1.Protective current-limiting resistors may be necessary to operate the LEDs within the specified range.
- 2.LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.





invalid Set-up

- 3. The driving circuit should be designed to protect the LED against reverse voltages and transient voltage spikes when the circuit is powered up or shut down.
- 4. The safe operating current should be chosen after considering the maximum ambient temperature of the operating environment.
- 5. Prolonged reverse bias should be avoided, as it could cause metal migration, leading to an increase in leakage current or causing a short circuit.